



**New Products**

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**Announcing Change of Manufacturing Location for Solid State Hall-effect Magnetic Sensor ICs**

**Summary**

Honeywell Sensing and Productivity Solutions (S&PS) will be transitioning the packaging of our Hall-effect and MR sensors from our packaging site in Juarez, MX to a new supplier in China. The die for these parts will remain unchanged and will continue to be fabricated in their original location.

The purpose of this announcement is to inform you of the transition. It should be noted that this is a change in packaging location only – there is no change to the internal die or form, fit and function of the sensor.

We intend to have the manufacture of these parts transferred to their new locations as early as February 2, 2016 per the schedule below:

Part Number	Transition Date
SS466A	2/15/2016
SS411A	4/30/2016
SS41	4/30/2016
SS496A	2/15/2016
SS496A1	2/15/2016
SS49E	2/15/2016
SS443A	2/2/2016
VF443A	2/2/2016
SS495A	4/30/2016
SS495A1	4/30/2016
SS495A2	2/15/2016
SS449A	2/15/2016
SS413A	2/2/2016
SS461A	4/30/2015
VF413A	2/2/2016

Part Number	Transition Date
SS441A	2/15/2016
SS491B	2/15/2016
SS495B	2/15/2016
SS496B	2/15/2016
SS494B	2/15/2016
SS40A	2/2/2016
SS40G	2/2/2016
SS43AF	2/2/2016
SS40A-F	2/2/2016
SS461C	2/2/2016
SS411P	2/2/2016
SS449R	2/2/2016
SS451A	2/2/2016
SS460P	2/2/2016

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Honeywell Sensing and Productivity Solutions

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